TOSHIBA Photocoupler Photorelay

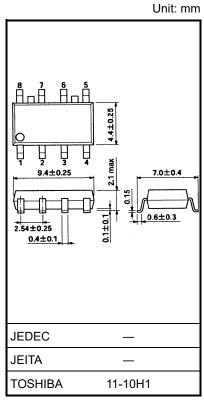
TLP206GA

PBX Telecommunication Modem · FAX Cards, Modems In PC Measurement Instrumentation

The TOSHIBA TLP206GA consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

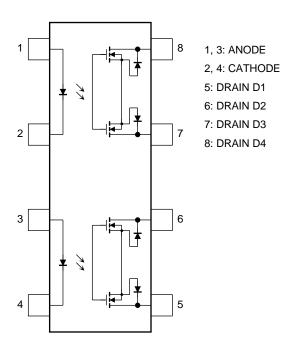
The TLP206GA is a 2-Form-A switch, which is suitable for replacement of mechanical relays in many applications.

- 8 pin SOP (2.54SOP8): 2.1 mm high, 2.54 mm pitch
- 2-form-A
- Peak off-state voltage: 400 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 35 Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349



Weight: 0.2 g (typ.)

Pin Configuration (top view)



Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
	Forward current	lF	50	mA
LED	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Peak forward current (100 µs pulse, 100 pps)	IFP	1	А
	Reverse voltage	VR	5	V
	Diode power dissipation	PD	50	mW
	Diode power dissipation derating (Ta $\ge 25^{\circ}$ C)	ΔP _D /°C	-0.5	mW/°C
	Junction temperature	Tj	125	°C
	Off-state output terminal voltage	Voff	400	V
	On-state current	ION	120	mA
ctor	On-state current derating (Ta \ge 25°C)	∆l _{ON} /°C	-1.2	mA/°C
Detector	Output power dissipation	Po	432	mW
	Output power dissipation derating (Ta \ge 25°C)	ΔPo/°C	-4.32	mW /°C
	Junction temperature	Tj	125	°C
Oper	rating temperature range	T _{opr}	-40 to 85	°C
Stora	age temperature range	T _{stg}	-55 to 125	°C
Lead	soldering temperature (10 s)	T _{sol}	260	°C
Isola	tion voltage (AC, 60 s, R.H. \leq 60 %) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	Vdd	—	_	320	V
Forward current	lF	5	7.5	25	mA
On-state current	ION	—		120	mA
Operating temperature	Topr	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	CT	V = 0 V, f = 1 MHz	_	30	_	pF
ector	Off-state current	IOFF	V _{OFF} = 400 V			1	μA
Detector	Capacitance	COFF	V = 0 V, f = 1 MHz		70		pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 120 mA	_	1	3	mA
Return LED current	IFC	loff = 100 μA	0.1	—		mA
On-state resistance	R _{ON}	I _{ON} = 120 mA, I _F = 5 mA	_	17	35	Ω

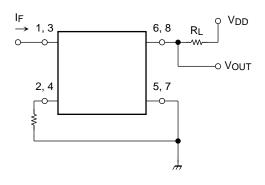
Isolation Characteristics (Ta = 25°C)

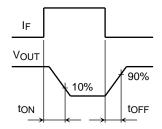
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	Vs = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	1500		_	Vrms

Switching Characteristics (Ta = 25°C)

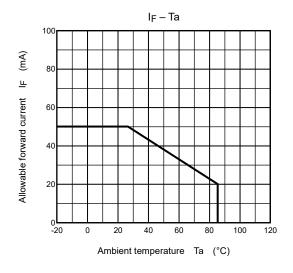
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	R _L = 200 Ω (Note 2)	_	0.3	1	ms
Turn-off time	tOFF	V _{DD} = 20 V, I _F = 5 mA		0.1	1	ms

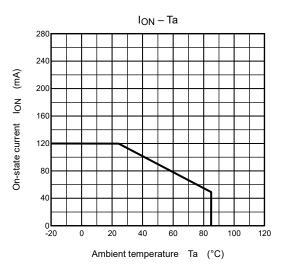
Note 2: Switching time test circuit

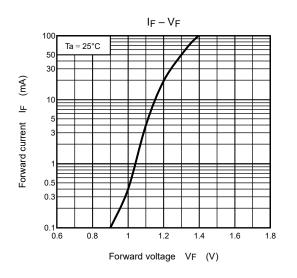


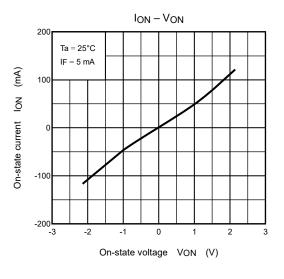


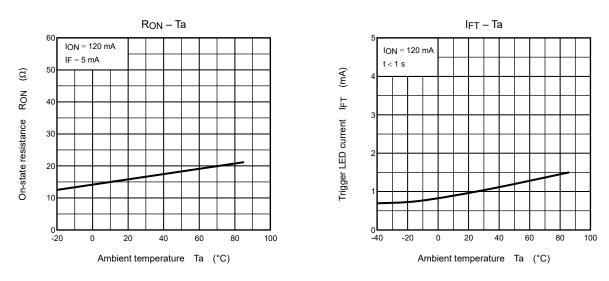
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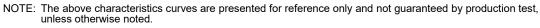


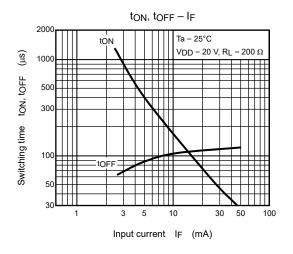


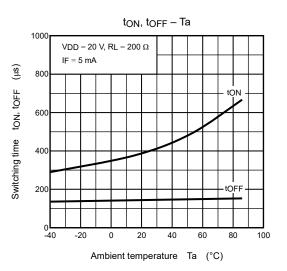


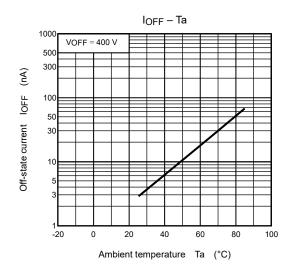












NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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